



Supporting Organization:



Event Partners:



Digital Policy Office
The Government of the
Hong Kong Special Administrative Region
of the People's Republic of China





Invitation to Sponsor: The Belt and Road Software Pavilion (Hong Kong) 2025

We are pleased to announce The Belt and Road Software Pavilion (Hong Kong) 2025, a major professional exhibition jointly organized by the Hong Kong Information Technology Joint Council and the Chamber of Hong Kong Computer Industry, with partnerships from the Digital Policy Office, the Hong Kong Chinese Enterprises Association of Information Technology Committee and the Hong Kong Software Industry Association and with support from the Belt and Road Office of the Commerce and Economic Development Bureau.

The Expo will be held from 21-23 August (Thursday to Saturday) at Hall 1, Hong Kong Convention and Exhibition Centre, occupying approximately 4,000 sqm of exhibition space with capacity for 120 exhibiting enterprises. This premier event will gather 120 leading software companies from Hong Kong, Mainland China, and other Belt and Road regions, targeting government departments, public institutions, and commercial organizations in Hong Kong.

This specialized software industry platform aims to:

- 1. Showcase R&D achievements and sector capabilities
- 2. Facilitate regional and international collaboration
- 3. Drive technological upgrades in organizational IT infrastructure
- 4. Establish itself as the premier software industry exposition across Belt and Road economies.

The success of our past events owes much to the steadfast support of industry partners and sponsors. We now cordially invite your esteemed company to sponsor this landmark event.

We sincerely hope your organization will become a sponsor of the Belt and Road Software Expo (Hong Kong) 2025. With your valued support, we are confident this edition will become an unforgettable success.

Enclosed please find the detailed sponsorship benefits package and reply slip. To confirm your sponsorship: 1. Complete the attached reply slip. 2. Mail with cheque (payable to: Hong Kong Information Technology Joint Council Limited) to our Secretariat. For enquiries, please contact: Tel: 2887-2018 / 2887-9113; Email: itjcsec@hkitjc.org.hk

We look forward to your favorable response.

Organizing Committee of The Belt and Road Software Pavilion (Hong Kong) 2025

Legislative Council Member (Technology and Innovation Constituency)

President,

Hong Kong Information Technology Joint Council

Legislative Council Member (Election Committee Constituency) Honorary President,

fioriorary Fresident,

Hong Kong Information Technology Joint Council

Chairman,

Organizing Committee 2025

Fax: 3020 6409

邱達根

黃錦輝

/a-=:m

June 2025



-帶一路軟件博覽館(香港)2025

05 June 2025





Supporting Organization:



Event Partners:







The Belt and Road Software Pavilion (Hong Kong) 2025

Platinum Sponsorship

Sponsorship Amount: HK\$300,000

Platinum Sponsors will be entitled to the following benefits:

- 1. Recognition as a Platinum Sponsor during the event.
- 2. Company name and logo featured as a Platinum Sponsor in all promotional materials, including websites and newspaper advertisements.
- 3. Two keynote speaking slots at the Mini Stage Forum during the Belt and Road Software Expo (Hong Kong) 2025.
- 4. Nine complimentary standard exhibition booths (9 sqm each) at the Belt and Road Software Expo (Hong Kong) 2025.
- 5. Priority selection of one of four prime exhibition booths at the venue entrance.

Note: Please return this reply slip via email to the Secretariat at iticsec@hkitic.org.hk at your earliest convenience.





Supporting Organization:



Event Partners:







The Belt and Road Software Pavilion (Hong Kong) 2025

Gold Sponsorship

Sponsorship Amount: HK\$200,000

Gold Sponsors will be entitled to the following benefits:

- 1. Recognition as a Gold Sponsor during the event.
- 2. Company name and logo featured as a Gold Sponsor in all promotional materials, including websites and newspaper advertisements.
- 3. One keynote speaking slot at the Mini Stage Forum during the Belt and Road Software Expo (Hong Kong) 2025.
- 4. Four complimentary standard exhibition booths (9 sqm each) at the Belt and Road Software Expo (Hong Kong) 2025.

Gold Sponsor Reply Slip

Our organization	organization is pleased to confirm our role as a Gold_					
Sponsor for the Belt and Road Software Ex	po (Hong Kong) 2025 with a sponsorship					
contribution of HK\$200,000.						
Contact Details:						
Contact Person:	Tel:					
Email:	Fax:					
Address:						
Authorized Signature:	Date:					
Name:	Position:					

Note: Please return this reply slip via email to the Secretariat at <u>itjcsec@hkitjc.org.hk</u> at your earliest convenience.





Supporting Organization:



Event Partners:







The Belt and Road Software Pavilion (Hong Kong) 2025

Silver Sponsorship

Sponsorship Amount: HK\$100,000

Silver Sponsors will be entitled to the following benefits:

- 1. Recognition as a Silver Sponsor during the event.
- 2. Company name and logo featured as a Silver Sponsor in all promotional materials, including websites and newspaper advertisements.
- 3. One keynote speaking slot at the Mini Stage Forum during the Belt and Road Software Expo (Hong Kong) 2025.

Silver Sponsor Reply Slip

Our organization	organizationis pleased to confirm our role as a <u>Silver</u>							
Sponsor for the Belt and Road Software Expo (Hong Kong) 2025 with a sponsorship								
contribution of HK\$100,000.								
Contact Details:								
Contact Person::	Tel:							
Email:	Fax:							
Address:								
Authorized Signature:	Date:							
Name:	Position:							

Note: Please return this reply slip via email to the Secretariat at <u>itjcsec@hkitjc.org.hk</u> at your earliest convenience.





Supporting Organization:



Event Partners:







"The Belt and Road Software Pavilion (Hong Kong) 2025" Booth Reservation

"The Belt and Road Software Pavilion (Hong Kong) 2025", a large-scale professional exhibition organized by the Hong Kong Information Technology Joint Council and the Chamber of Hong Kong Computer Industry, with partnerships from the Digital Policy Office, the Hong Kong Chinese Enterprises Association of Information Technology Committee and the Hong Kong Software Industry Association, and with support from the Belt and Road Office of the Commerce and Economic Development Bureau, will be held from August 21 to 23, 2025 (Thursday to Saturday) at Hall 1 of the Hong Kong Convention and Exhibition Centre.

Covering approximately 4,000 square meters, the exhibition hall can accommodate up to 120 exhibitors. It will gather 120 top-tier software enterprises from Hong Kong, Mainland China, and other Belt and Road regions, targeting clients such as the Hong Kong government, public institutions, and commercial organizations. The expo aims to serve as a specialized platform for the software industry to showcase R&D achievements and sector strengths, foster regional and international collaboration, drive technological upgrades in institutional IT capabilities, and establish itself as a premier software industry event for Belt and Road regions.

Hong Kong exhibitors participating in this edition may apply for the "SME Export Marketing Fund" (SME Funding) under the Trade and Industry Department. The subsidized expenses include booth rental, advertising fees, booth construction, decoration and design fees, etc. Successful applicants may receive funding of up to 25% of the approved total expenses or a maximum of HKD 100,000.

Booth Reservat	ion Details					
Date	August 21 to 23, 2025 (Thursday to Saturday)					
Venue	Hall 1, Hong Kong Convention and Exhibition Centre					
Participation	Standard booth - HK\$33,000 per 9 square meters					
Fee	(please contact our secretariat if you apply for raw space booth)					
Performance Bond Deposit	Based on fire and safety regulations, the Hong Kong Convention and Exhibition Centre has started collecting a "Performance Bond Deposit" since 2012. Exhibitors are required to pay a "Performance Bond Deposit" according to the size of the booth area. Exhibitors with a booth area below 50 square meters are required to pay HK\$7,000, and those with a booth area above 50 square meters are required to pay HK\$14,000. The deposit will be refunded by cheque within 60 days after the end of "The Belt and Road Software Pavilion (Hong Kong) 2025" to all exhibitors who have not violated any regulations.					
Application Procedures	 Please fill in the attached application form and email it to the secretariat of the Hong Kong Information Technology Joint Council: itjcsec@hkitjc.org.hk. After receiving notification from the secretariat of the Hong Kong Information Technology Joint Council to confirm the booth, please pay the deposit within one week with the cheque together for the "Participation Fee" and "Performance Bond Deposit", and mail it to the secretariat of the Hong Kong Information Technology Joint Council. Cheque payable to: "Hong Kong Information Technology Joint Council Limited" - Address: 23rd Floor, Global Trade Square, 21 Wong Chuk Hang Road, Aberdeen, Hong Kong. Please mark on the envelope: "The Belt and Road Software Pavilion (Hong Kong) 2025" Reservation Application 					

Note

- 1. The priority of booth selection is determined by the size of the reserved booth area, allocated as follows: event sponsors can choose the location first, and the order of processing booths for other exhibiting companies is determined by the actual size of the booth area ordered, advertising, sponsorship items, etc. If there is a difference between the reserved booth area and the actual subscribed area, the actual subscribed booth area shall prevail.
- 2. All booth reservations must pay the performance bond deposit, otherwise the reservation application will not be accepted.
- 3. Companies reserving booths are not allowed to change the exhibiting name, transfer or sublet the booth.
- 4. The organizer reserves the right to change the exhibition plan or venue arrangement at any time, and has the full authority to allocate and plan the location of each exhibition area and booth, without prior notice to exhibitors.
- 5. The organizer has the right to modify the layout of the exhibition venue and/or relocate the booths allocated to exhibitors when necessary.

If you wish to reserve a booth, please call 2887-9113/2887-2018 or email <u>itjcsec@hkitjc.org.hk</u> to inquire with Ms. He or Ms. Ching.

Secretariat of the Hong Kong Information Technology Joint Council

June 2025

*The plan is ultimately based on the final government-approved drawings and legal documents.

B&RSP (HK) 202 Exhibition Application Form

			Exhibitor'	s Information			
Company Name (Eng	llish)						
Company Name (Chi	nese)						
Company Address							
Contact Person				Position			
Tel				E-mail			
Mobile					ı		
			Exhibit	ting Products			
Please briefly describ	e:						
			Exhi	biting Size			
	Each sta	ndard booth has a	a unified area of 9 s		ong x 3m wide	x 2.47m height).	
		Standard Boo		1	•	unit(s)	
				of Payments			
Crossed cheque paya Address: 23rd Floor, (Application")	_	•	• • • • • • • • • • • • • • • • • • • •			K (Please mark:	"B&RSP(HK)2025 Exhibition
Cheque: Performance	bond deposit						
Amount:		Bank :	'				
=lnt	erested in applying	for the govern		Others	ions must bo	submitted by	vour company)
Confirm of Application		ior the govern	illient's Sivie Fu	nding (applicat	ions must be	зиринцей ру у	our company)
□Exhibition Applicati							
□Performance Bond							
□ BR							
			Company (Chop & Signatur	e		
We a	ree to accept and	abide by all the	terms listed on	"Exhibition Appli	ication Form"	and "Terms	& Conditions" .
Name					Date		
Company chop & au	thorized signature				Position		
For Official Use Only							
Booth No.:			Chec	que:		Paid Date:	

^{*} please hand in the BR copy together with the application form.

^{*} All data are for application only. HKITJC makes no guarantee to all applications.

^{*} The Organizer reserves the right to cancel, alter in nature, scale, shorten or extend the duration of the Exhibition , amend floorplan and reallocate booths at any time without incurring any liability.

^{*} All deposits are non refundable.